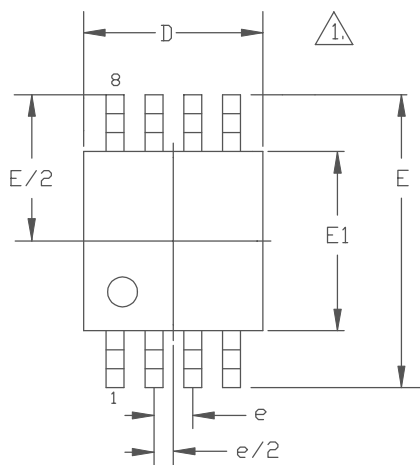
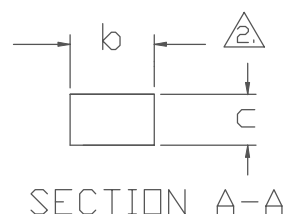
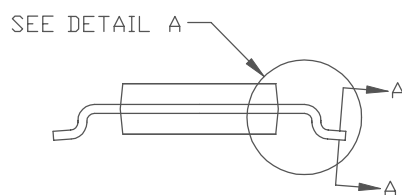
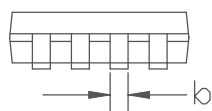


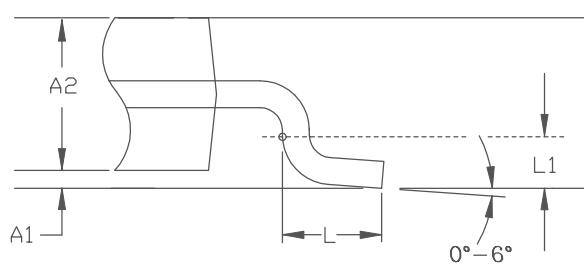


1. DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 MM PER SIDE

2. SECTION A-A DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.13 TO 0.25 MM FROM THE LEAD TIP.



DIM	MIN	NOM	MAX
A	-	-	1.10
A ₁	0.05	-	0.15
A ₂	0.75	0.85	0.95
b	0.25	-	0.40
C	0.13	-	0.23
D	2.90	3.00	3.10
E	4.90 BSC		
E ₁	2.90	3.00	3.10
e	0.65 BSC		
L	0.40	0.55	0.70
L ₁	0.25 BSC		



DETAIL A

DIMENSIONS ARE IN MILLIMETERS

SIGNATURE		DATE		Dallas Semiconductor TITLE: MARKETING OUTLINE, 8 LEAD, MICRO-SOP, 3.0 MM BODY			
DOC. CONTROL: J.H.		12/99					
ENGR. MGR:				SIZE	FSCM NO.	PART NO.	REV.
MFG. ENGR:				A		56-G2018-001	C
CHECKED BY: T.W.M.		11/99					
DRAWN BY: N.L.K.		11/99					
				SCALE	N/A	SHEET	1 of 1